TOSHIBA TLP665JF

TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

TLP665JF

OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER **SOLID STATE RELAY**

The TOSHIBA TLP665JF consists of a photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP. All parameters are tested to the specification of TLP665J. (both condition and limits)

Peak Off-State Voltage: 600V (Min.) Trigger LED Current 10mA (Max.) On-State Current 100mA (Max.)

UL Recognized UL1577, File No. E67349

Isolation Voltage $5000V_{rms}$ (Min.)

Option (D4) type

VDE Approved DIN VDE0884/08.87, Certificate No. 68383

Maximum Operating Insulation Voltage: $630V_{PK}$ Highest Permissible Over Voltage : 6000Vpk

(Note 1) When a VDE0884 approved type is needed, please designate the "Option (D4)"
Structural Parameter

Creepage Distance : 8.0mm (Min.) Clearance : 8.0mm (Min.) **Insulation Thickness** : 0.5mm (Min.)

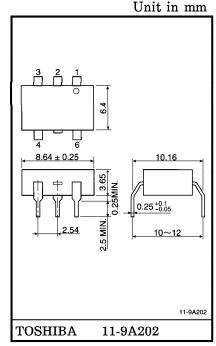
Conforming Safety Standards:

DIN 57 804/VDE0804/1.83 DIN IEC65/VDE0860/8.81 DIN IEC380/VDE0806/8.81

DIN IEC435/VDE0805/Draft Nov. 84

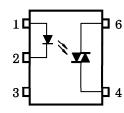
DIN IEC601T1/VDE0750T1/5.82

BS7002: 1989 (EN60950)



Weight: 0.44g

PIN CONFIGURATIONS (TOP VIEW)



1: ANODE 2: CATHODE 3 : NC

4: TERMINAL 1 6: TERMINAL 2

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